DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

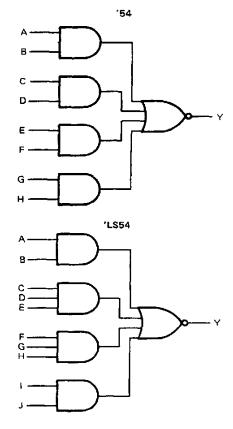
#### description

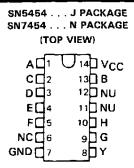
These devices contain 4-wide AND-OR-INVERT gates. They perform the following Boolean functions:

'54 Y = 
$$\overrightarrow{AB}$$
 +  $\overrightarrow{CD}$  +  $\overrightarrow{EF}$  +  $\overrightarrow{GH}$   
LS54 Y =  $\overrightarrow{AB}$  +  $\overrightarrow{CDE}$  +  $\overrightarrow{FGH}$  +  $\overrightarrow{IJ}$ 

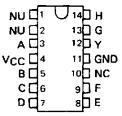
The SN5454 and SN54LS54 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125 $\,^{\circ}\text{C}$ . The SN7454 and SN74LS54 are characterized for operation from 0 $\,^{\circ}\text{C}$  to 70 $\,^{\circ}\text{C}$ .

#### logic diagrams (positive logic)

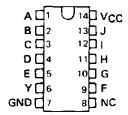




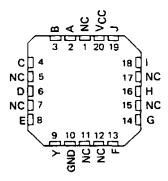
SN5454 . . . W PACKAGE (TOP VIEW)



SN54LS54 . . . J OR W PACKAGE SN74LS54 . . . D OR N PACKAGE (TOP VIEW)



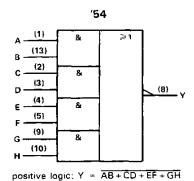
SN54LS54 . . . FK PACKAGE (TOP VIEW)

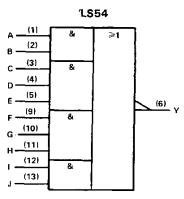


NC-No internal connection
NU-Make no external connection

## SN5454, SN54LS54, SN7454, SN74LS54 4-WIDE AND-OR-INVERT GATES

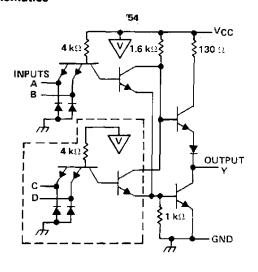
#### logic symbols†

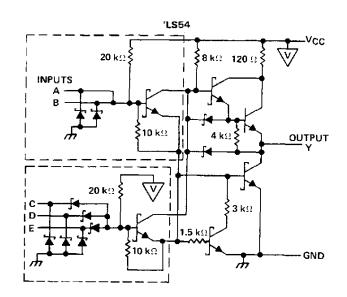




positive logic:  $Y = \overline{AB + CDE + FGH + IJ}$ 

#### schematics





Resistor values shown are nominal.

The portion of the circuits within the dashed lines is repeated for each additional 2- or 3-input AND section, as shown in the logic diagram and logic symbols.

<sup>&</sup>lt;sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N package. For the SN54LS54 only, they apply also for the W package.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note   | 1)     | 7 V            |
|---------------------------------|--------|----------------|
| Input voltage                   |        | 5.5 V          |
| Operating free-air temperature: | SN5454 | -55°C to 125°C |
|                                 | SN7454 | 0°C to 70°C    |
| Storage temperature range       |        | -65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|     |                                |             | \$N5454 |       |      | SN7454 |       |      |  |
|-----|--------------------------------|-------------|---------|-------|------|--------|-------|------|--|
|     |                                | MIN         | NOM     | MAX   | MIN  | NOM    | MAX   | UNIT |  |
| Vcc | Supply voltage                 | 4.5         | 5       | 5.5   | 4.75 | 5      | 5.25  | V    |  |
| VIH | High-level input voltage       | 2           |         |       | 2    |        |       | ٧    |  |
| VIL | Low-level input voltage        |             |         | 9.0   |      |        | 8.0   | ٧    |  |
|     | High-level output current      |             |         | - 0.4 |      | -      | - 0.4 | mΑ   |  |
| IOL | Low-level output current       |             |         | 16    |      |        | 16    | mA   |  |
|     | Operating free-air temperature | <b>– 55</b> |         | 125   | 0    |        | 70    | °C   |  |

## electrical characterics over recommended operating free-air temperature range (unless otherwise noted)

|                | TEST CONSTITUTE  |          | SN5454 |             |      |       | SN7454      |      |  |  |
|----------------|--|----------|--------|-------------|------|-------|-------------|------|--|--|
| PARAMETER      | TEST CONDITIONS†   | MIN      | TYP‡   | MAX         | MIN  | TYP ‡ | MAX         | UNIT |  |  |
| ViK            | V <sub>CC</sub> = MIN. I <sub>1</sub> = - 12 mA                    |          |        | - 1.5       |      |       | - 1.5       | V    |  |  |
| νон            | VCC = MIN, VIL = 0.8 V, IQH = -                                    | 0.4 mA 2 | 4 3.4  |             | 2.4  | 3.4   |             | V    |  |  |
| VOL            | V <sub>CC</sub> = MIN. V <sub>1H</sub> = 2 V, I <sub>OL</sub> = 10 | mA       | 0.2    | 0.4         | ]    | 0.2   | 0.4         | ٧    |  |  |
| I <sub>I</sub> | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V                      |          |        | 1           |      |       | 1           | mA   |  |  |
| ΊΗ             | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V                      |          |        | 40          |      |       | 40          | μΑ   |  |  |
| l L            | V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V                      |          |        | - 1.6       |      |       | - 1.6       | mA   |  |  |
| losÿ           | V <sub>CC</sub> = MAX  | - 2      | 0      | <b>– 55</b> | - 18 |       | <b>– 55</b> | mA   |  |  |
| Іссн           | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0 V                        |          | 4      | 8           |      | 4     | 8           | mΑ   |  |  |
| ICCL           | V <sub>CC</sub> = MAX, See Note 2                                  |          | 5.1    | 9.5         |      | 5.1   | 9.5         | mΑ   |  |  |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT)                        | TEST CONDITIONS                    | MIN TY | P MAX | UNIT |
|-----------|-----------------|---------------------------------------|------------------------------------|--------|-------|------|
| †PLH      | 0               | V                                     | $R_1 = 400 \Omega$ , $C_1 = 15 pF$ | 1      | 3 22  | ns   |
| tPHL.     | Апу             | · · · · · · · · · · · · · · · · · · · | A[ - 400 32,                       |        | 8 15  | ns - |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

## SN54LS54, SN74LS54 4-WIDE AND-OR-INVERT GATES

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note   | 1)       | <br> | <br> | <br>         | 7 '            | ٧ |
|---------------------------------|----------|------|------|--------------|----------------|---|
| Input voltage                   |          | <br> | <br> | <br><b>.</b> | 7 '            | ٧ |
| Operating free-air temperature: | SN54LS54 | <br> | <br> | <br>         | -55°C to 125°  | С |
|                                 | SN74LS54 | <br> | <br> | <br>         | 0°C to 70°C    | С |
| Storage temperature range       |          | <br> | <br> | <br>         | -65°C to 150°C | С |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|                |                                | s    | SN54LS54 |       |      | SN74LS54 |       |      |  |
|----------------|--------------------------------|------|----------|-------|------|----------|-------|------|--|
|                |                                | MIN  | NOM      | MAX   | MIN  | NOM      | MAX   | UNIT |  |
| Vcc            | Supply voltage                 | 4.5  | 5        | 5.5   | 4.75 | 5        | 5.25  | V    |  |
| VIH            | High-level input voltage       | 2    |          |       | 2    |          |       | ٧    |  |
| VIL            | Low-level input voltage        |      |          | 0.7   |      |          | 8.0   | V    |  |
| Іон            | High-level output current      |      |          | - 0.4 |      |          | - 0.4 | mA   |  |
| OL             | Low-level output current       |      |          | 4     |      |          | 8     | mΑ   |  |
| τ <sub>A</sub> | Operating free-air temperature | - 55 |          | 125   | 0    |          | 70    | °c   |  |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | !                      | S                      | N54LS         | i4   | S     |       |      |      |              |     |
|------------------|------------------------|------------------------|---------------|------|-------|-------|------|------|--------------|-----|
|                  | TEST CONDITIONS†       | TYP \$                 | MAX           | MIN  | TYP ‡ | MAX   | דומט |      |              |     |
| Vικ              | VCC = MIN,             | l <sub>1</sub> = 18 mA |               |      |       | - 1.5 |      |      | - 1.5        | * V |
| Voн              | VCC = MIN,             | VIL = MAX,             | OH = - 0.4 mA | 2.5  | 3.4   | -     | 2.7  | 3.4  |              | V   |
| VOL              | V <sub>CC</sub> = MIN, | V <sub>(H</sub> = 2 V, | IOL = 4 mA    |      | 0.25  | 0.4   |      | 0.25 | 0.4          |     |
| • OL             | V <sub>CC</sub> = MIN  | V <sub>IH</sub> = 2 V, | IOL = 8 mA    |      |       |       |      | 0.35 | 0.5          | V   |
| lj               | VCC = MAX,             | V <sub>1</sub> = 7 V   |               |      |       | 0.1   |      |      | 0.1          | mA  |
| ЧН               | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 2.7 V |               |      |       | 20    |      |      | 20           | μА  |
|                  | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 0.4 V |               | 7    |       | - 0.4 |      |      | - 0.4        | mA  |
| losş             | V <sub>CC</sub> = MAX  | <u></u> -              |               | - 20 |       | - 100 | - 20 |      | <b>– 100</b> | mΑ  |
| Іссн             | V <sub>CC</sub> = MAX, | V; = 0 V               |               |      | 8.0   | 1.6   |      | 8.0  | 1.6          | mΑ  |
| <sup>1</sup> CCL | V <sub>CC</sub> = MAX, | See Note 2             |               |      | 1     | 2     |      | 1    | 2            | mΑ  |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                         | MIN | TYP  | MAX | UNIT |
|------------------|-----------------|----------------|---|-----|------|-----|------|
| tPLH             | Anv             | v              | $R_1 \approx 2 k\Omega$ , $C_1 = 15 pF$ |     | 12   | 20  | ns   |
| <sup>t</sup> PHL |                 | ·              |   | [   | 12.5 | 20  | กร   |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$  All typical values are at VCC = 5 V, TA = 25°C.

<sup>§</sup>Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.





3-May-2013

#### **PACKAGING INFORMATION**

| Orderable Device | Status   | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|----------|--------------|--------------------|------|----------------|----------|------------------|--------------------|--------------|-------------------|---------|
| SN5454J          | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SN5454J           | Samples |
| SN54LS54J        | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SN54LS54J         | Samples |
| SN54LS54J        | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SN54LS54J         | Samples |
| SN7454N          | OBSOLETE | PDIP         | N                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN7454N          | OBSOLETE | PDIP         | N                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54D        | OBSOLETE | SOIC         | D                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54D        | OBSOLETE | SOIC         | D                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54DR       | OBSOLETE | SOIC         | D                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54DR       | OBSOLETE | SOIC         | D                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54J        | OBSOLETE | CDIP         | J                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54J        | OBSOLETE | CDIP         | J                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54N        | OBSOLETE | PDIP         | N                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SN74LS54N        | OBSOLETE | PDIP         | N                  | 14   |                | TBD      | Call TI          | Call TI            | 0 to 70      |                   |         |
| SNJ5454J         | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ5454J          | Sample  |
| SNJ5454J         | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ5454J          | Sample  |
| SNJ5454W         | NRND     | CFP          | W                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ5454W          |         |
| SNJ5454W         | NRND     | CFP          | W                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ5454W          |         |
| SNJ54LS54FK      | OBSOLETE |              |                    | 20   |                | TBD      | Call TI          | Call TI            | -55 to 125   |                   |         |
| SNJ54LS54FK      | OBSOLETE |              |                    | 20   |                | TBD      | Call TI          | Call TI            | -55 to 125   |                   |         |
| SNJ54LS54J       | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS54J        | Sample  |
| SNJ54LS54J       | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS54J        | Sample  |
| SNJ54LS54W       | ACTIVE   | CFP          | W                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS54W        | Sample  |
| SNJ54LS54W       | ACTIVE   | CFP          | W                  | 14   | 1              | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS54W        | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.



#### PACKAGE OPTION ADDENDUM



3-May-2013

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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#### OTHER QUALIFIED VERSIONS OF SN5454, SN54LS54, SN7454, SN74LS54:

Catalog: SN7454, SN74LS54

Military: SN5454, SN54LS54

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F14)

# CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



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